

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	760426	(ball bump)	US-PGPU B; USPAT; USOCR	OR	ON	2008/01/12 15:06
L2	7133	1 and (trace near8 substrate)	US-PGPU B; USPAT; USOCR	OR	ON	2008/01/12 15:06
L3	5445	2 and ((bump ball) near15 (IC chip substrate wafer))	US-PGPU B; USPAT; USOCR	OR	ON	2008/01/12 15:07
L4	3230	3 and (flip near5 chip)	US-PGPU B; USPAT; USOCR	OR	ON	2008/01/12 15:07
L5	959	4 and (die near20 substrate near20 ball)	US-PGPU B; USPAT; USOCR	OR	ON	2008/01/12 14:29
L6	373442	(ball bump)	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/12 15:06
L7	559	6 and (trace same substrate)	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/12 15:07
L8	472	7 and ((bump ball) same (IC chip substrate wafer))	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/12 15:07
L10	111	8 and (flip same chip)	FPRS; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2008/01/12 15:08